



### Dimensions

Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	2mm MAX
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
K	1.7mm TYP

### Packaging Specifications

Packaging	T&R, 330mm
Packaging Quantity	3750

### General Information

Dielectric	MnO <sub>2</sub> Tantalum
Style	SMD Chip
Description	SMD, Molded, Low Profile, Low ESR, Surge Robust
Features	Low Profile, Low ESR, Surge Robust
RoHS	Yes
Termination	Tin
AEC-Q200	No
Notes	Obsolete. Old Part Number [Obsolete] Was B45035V1066M607.

### Specifications

Capacitance	10 uF
Capacitance Tolerance	20%
Voltage DC	35 VDC (85C), 23.45 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	6%
Failure Rate	N/A
ESR	0.6 Ohms (100kHz)
Ripple Current	460 mAmps (25C), 414 mAmps (85C), 184 mAmps (125C)
Leakage Current	3.5 uA